



/ Revised record

	□ □		的测试条件原先为： 改成：		
	□ □				
	□ □		英文描述 更正为		

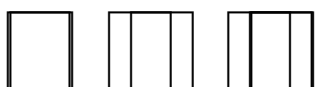
/ Features

/ Applications

/ **Marking**

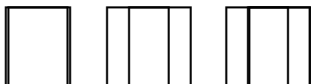
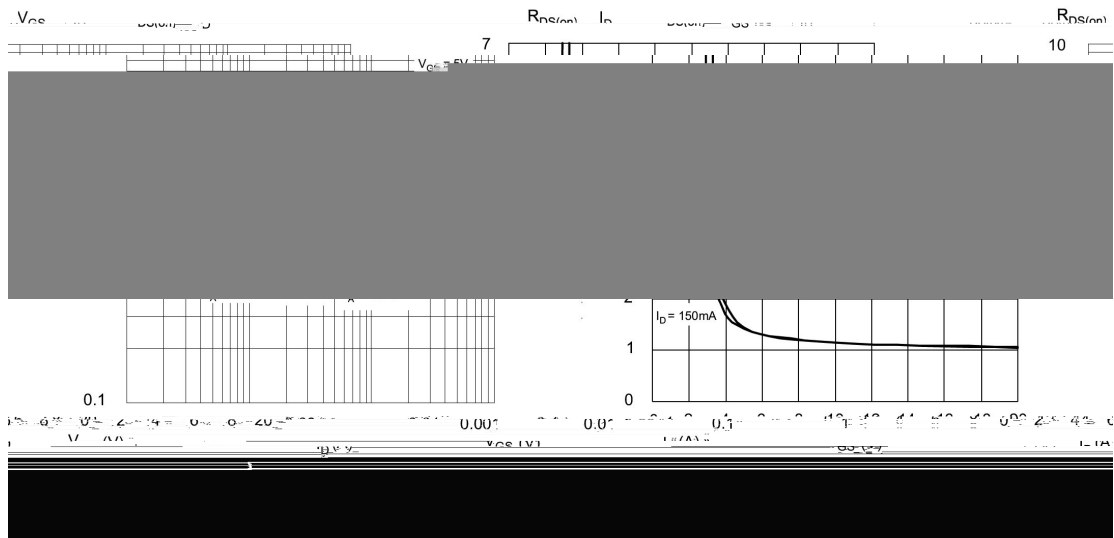
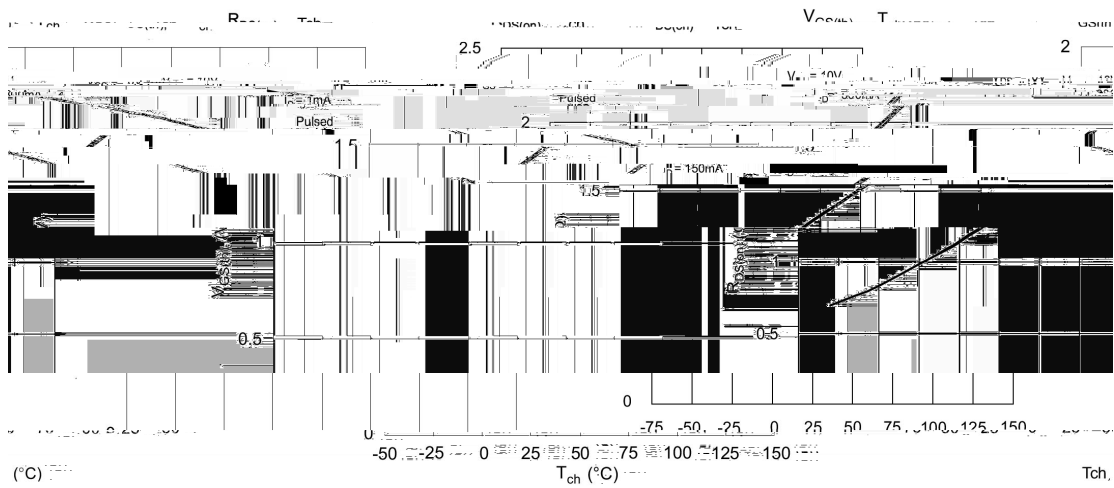
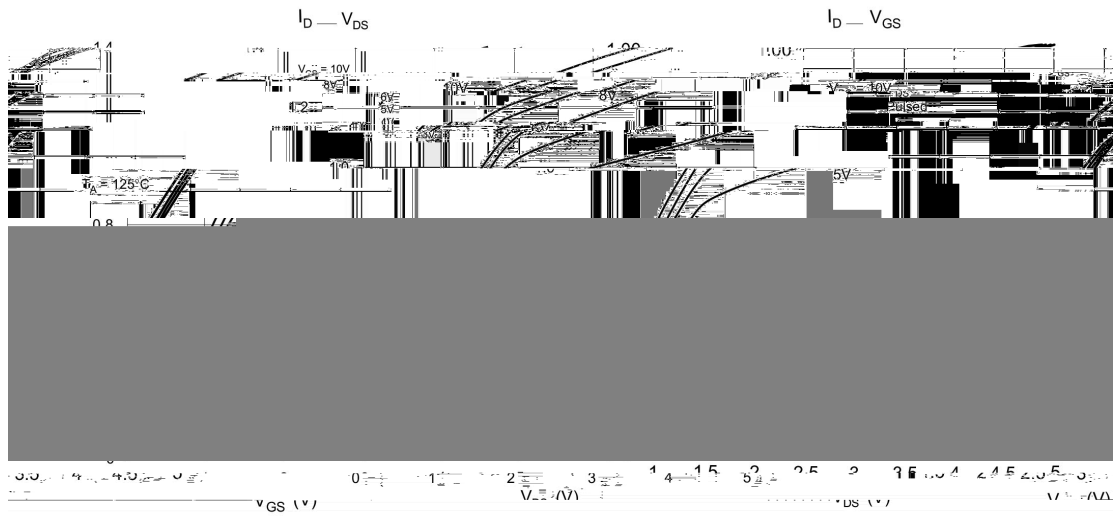
The diagram shows three rectangles. The first rectangle is a single unit square. The second rectangle is a unit square divided into two equal vertical halves. The third rectangle is a unit square divided into three equal vertical thirds.

/ Electrical Characteristics(Ta=25)

[illegible]



/ Electrical Characteristic Curve

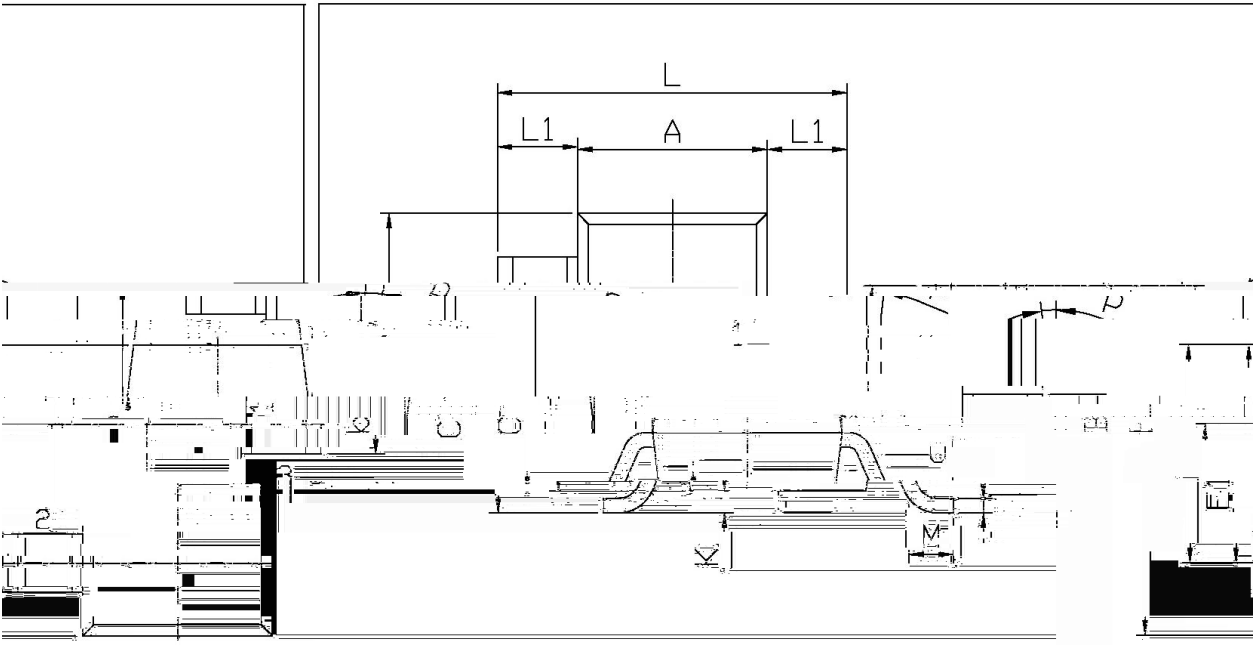




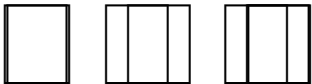
/ Package Dimensions

Symbol; Unit

Symbol; Unit

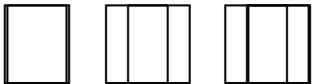
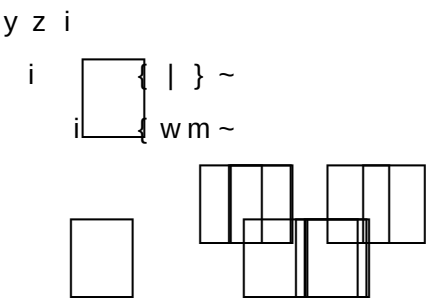
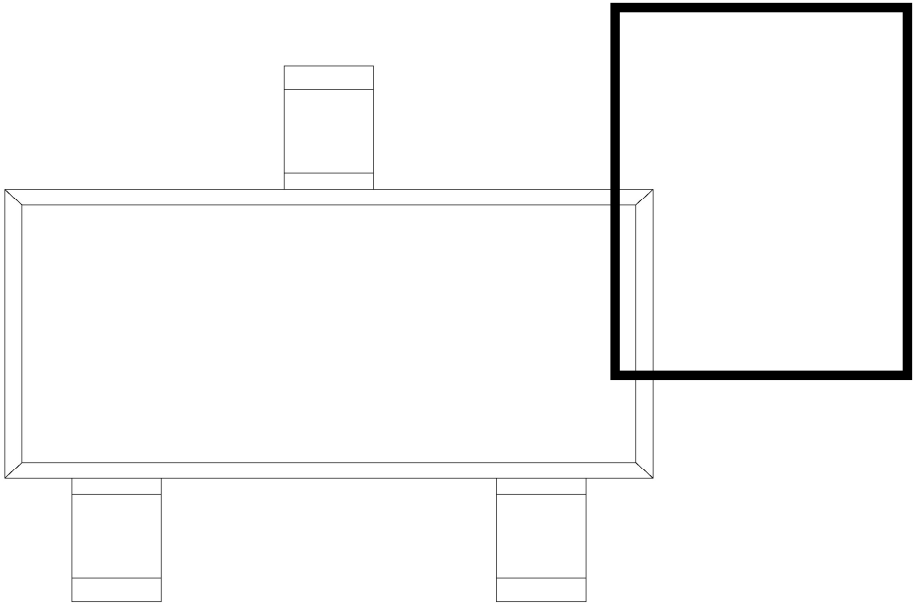


Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
A	1.15	1.50	E	0.65	0.90
B	2.70	3.10	K	0.10	0.20
				0.85	0.95
				0.35	0.55





/ Marking Instructions





() / Temperature Profile for IR Reflow Soldering(Pb-Free)

说明：
、预热温度 ~ °C，时间 ~
、峰值温度 ± °C，时间持续为 ±
、焊接制程冷却速度为 ~ °C

/ Resistance to Soldering Heat Test Conditions

温度： ± °C 时间： ± °C